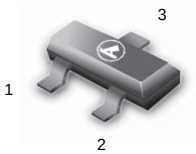
General Purpose Transistors

NPN Silicon

L2SC2412KQLT1G Series
L2SC2412KQLT1G Series

- We declare that the material of product compliance with RoHS requirements.
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.



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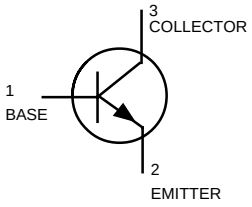
ORDERING INFORMATION

Device	Marking	Shipping
L2SC2412KQLT1G S-L2SC2412KQLT1G	BQ	3000 Tape & Reel
L2SC2412KQLT3G S-L2SC2412KQLT3G	BQ	10000 Tape & Reel
L2SC2412KRLT1G S-L2SC2412KRLT1G	BR	3000 Tape & Reel
L2SC2412KRLT3G S-L2SC2412KRLT3G	BR	10000 Tape & Reel
L2SC2412KSLT1G S-L2SC2412KSLT1G	G1F	3000 Tape & Reel
L2SC2412KSLT3G S-L2SC2412KSLT3G	G1F	10000 Tape & Reel

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CEO}	50	V
Collector–Base Voltage	V_{CBO}	60	V
Emitter–Base Voltage	V_{EBO}	7.0	V
Collector Current — Continuous	I_C	150	mAdc
Collector power dissipation	P_C	0.2	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 —+150	°C



DEVICE MARKING

L2SC2412KQLT1G =BQ L2SC2412KRLT1G =BR L2SC2412KSLT1G =G1F

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Collector–Emitter Breakdown Voltage (I_C = 1 mA)	$V_{(BR)CEO}$	50	—	—	V
Emitter–Base Breakdown Voltage (I_E = 50 µA)	$V_{(BR)EBO}$	7	—	—	V
Collector–Base Breakdown Voltage (I_C = 50 µA)	$V_{(BR)CBO}$	60	—	—	V
Collector Cutoff Current (V_{CB} = 60 V)	I_{CBO}	—	—	0.1	µA
Emitter cutoff current (V_{EB} = 7 V)	I_{EBO}	—	—	0.1	µA
Collector-emitter saturation voltage (I_C/ I_B = 50 mA / 5m A)	$V_{CE(sat)}$	—	—	0.4	V
DC current transfer ratio (V_{CE} = 6 V, I_C= 1mA)	h_{FE}	120	—	560	—
Transition frequency (V_{CE} = 12 V, I_E= – 2mA, f =30MHz)	f_T	—	180	—	MHz
Output capacitance (V_{CB} = 12 V, I_E= 0A, f =1MHz)	C_{ob}	—	2.0	3.5	pF

h_{FE} values are classified as follows:

*	Q	R	S
hFE	120~270	180~390	270~560

Fig.1 Grounded emitter propagation characteristics

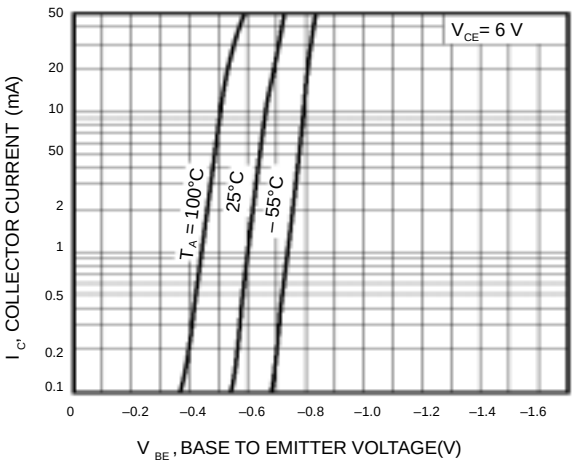


Fig.2 Grounded emitter output characteristics(Ⅰ)

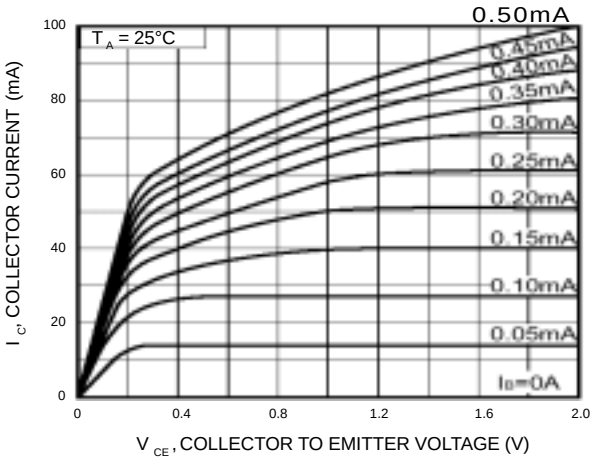


Fig.3 Grounded emitter output characteristics(Ⅱ)

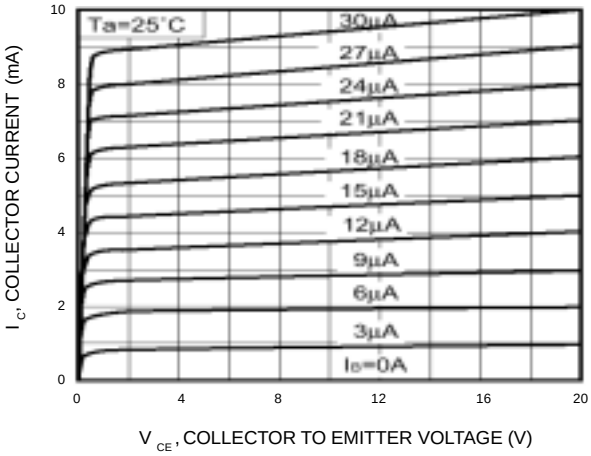


Fig.4 DC current gain vs. collector current (Ⅰ)

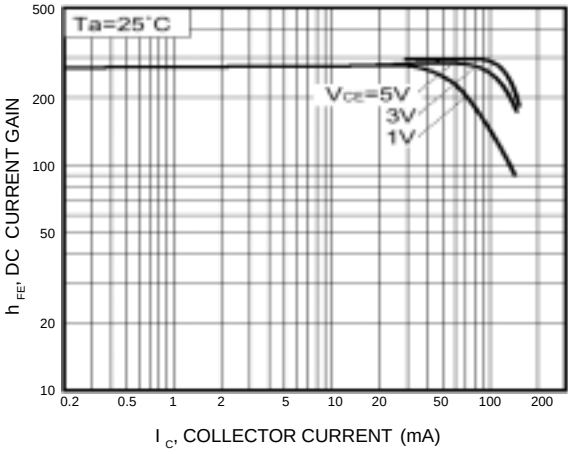


Fig.5 DC current gain vs. collector current (Ⅱ)

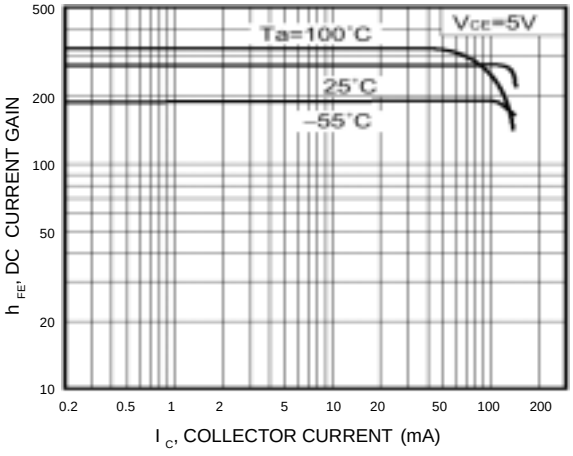


Fig.6 Collector-emitter saturation voltage vs. collector current

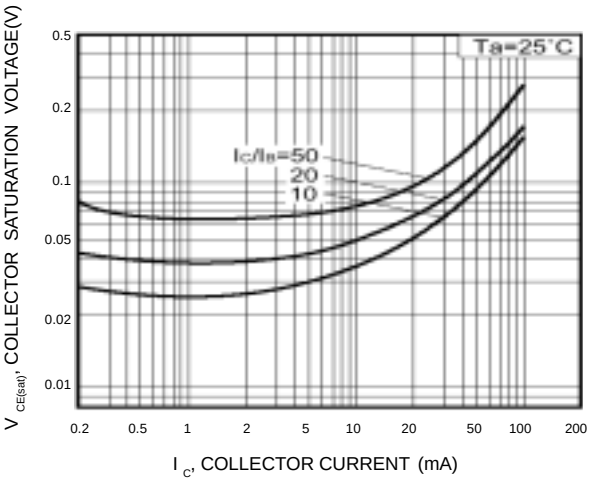


Fig.7 Collector-emitter saturation voltage vs. collector current (Ⅰ)

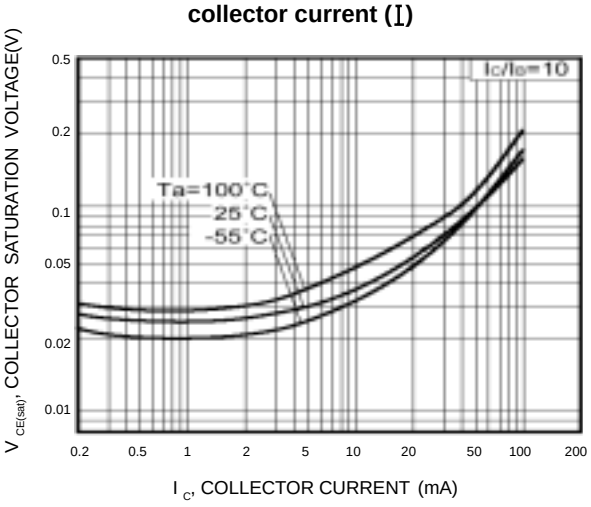


Fig.8 Collector-emitter saturation voltage vs. collector current (Ⅱ)

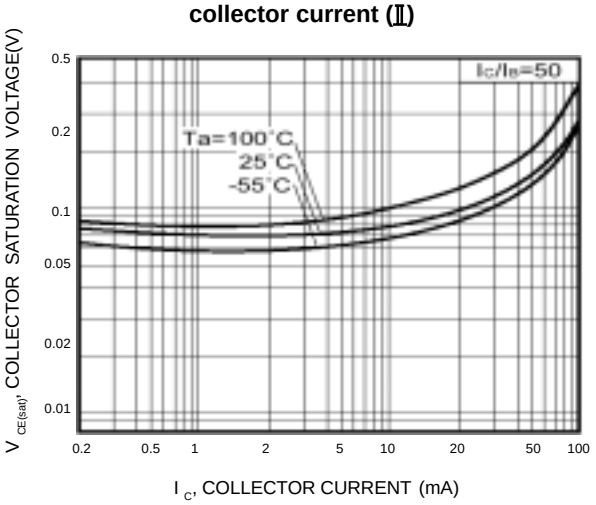


Fig.9 Gain bandwidth product vs. emitter current

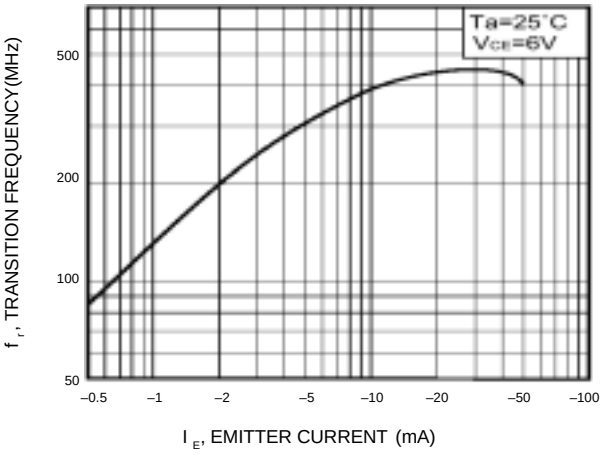


Fig.10 Collector output capacitance vs.collector-base voltage Emitter inputcapacitance vs. emitter-base voltage

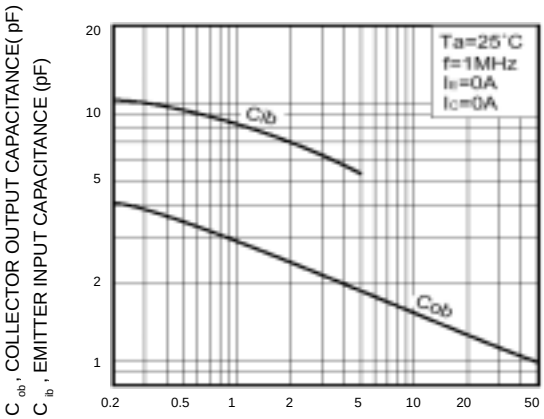
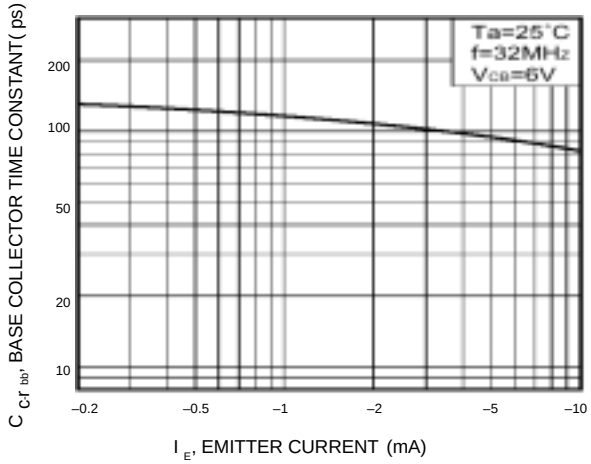


Fig.11 Base-collector time constant vs.emitter current



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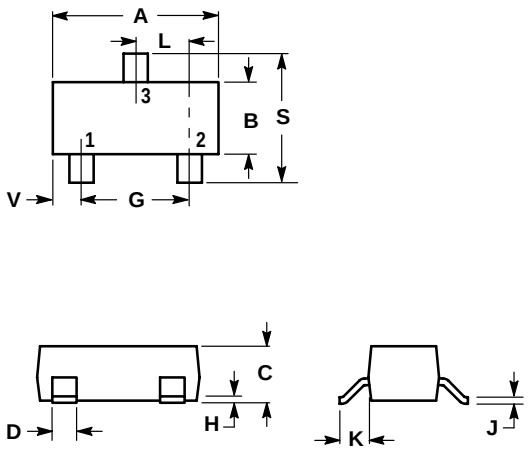

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,1982
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60